



Power MOSFETS

DATASHEET

LM40060NAQ8A

N-Channel
Enhancement Mode MOSFET

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Quality Management Systems
ISO 9001:2015 Certificate

N-Channel Enhancement Mode MOSFET

Pin Description

SOP-8L	Symbol	Symbol	N-Channel	Unit
		V_{DSS}	40	V
		$R_{DS(ON)-Max}$	5.3	$\text{m}\Omega$
		ID	13.8	A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested

Applications

- Portable Equipment
- Battery Powered System

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM40060NAQ8A	SOP-8L	Tape & Reel	3000 / Tape & Reel	40060 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V_{DSS}	Drain-Source Voltage	40	V
V_{GSS}	Gate-Source Voltage	± 20	
T_J	Maximum Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
I_S	Diode Continuous Forward Current	$T_A=25^\circ\text{C}$	A
$I_{DM}^{(1)}$	Pulse Drain Current Tested	$T_A=25^\circ\text{C}$	A
I_D	Continuous Drain Current	$T_A=25^\circ\text{C}$	13.8
		$T_A=100^\circ\text{C}$	8.7
P_D	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	1.5
		$T_A=100^\circ\text{C}$	0.9
$I_{AS}^{(2)}$	Avalanche Current, Single pulse	$L=0.1\text{mH}$	16
		$L=0.5\text{mH}$	8
$E_{AS}^{(2)}$	Avalanche Energy, Single pulse	$L=0.1\text{mH}$	13
		$L=0.5\text{mH}$	16

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}^{(3)}$	Thermal Resistance-Junction to Ambient	$t \leq 10\text{s}$	$^\circ\text{C/W}$
		Steady State	$^\circ\text{C/W}$

Note ① : Max. current is limited by junction temperature

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

N-Channel Electrical Characteristics (T_J=25°C Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250μA	40	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V _{DS} =32V, V _{GS} =0V	-	-	1	μA
V_{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250μA	1	1.5	2	V
I_{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
R_{DS(ON)}^④	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =20A	-	4.4	5.3	mΩ
		V _{GS} =4.5V, I _{DS} =10A	-	6.2	8	
g_fs	Forward Transconductance	V _{DS} =5V, I _{DS} =10A	-	12	-	S
Dynamic Characteristics^⑤						
R_G	Gate Resistance	V _{GS} =0V, V _{DS} =0V, Freq.=1MHz	-	2.3	-	Ω
C_{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =20V, Freq.=1MHz	-	927	-	pF
C_{oss}	Output Capacitance		-	366	-	
C_{rss}	Reverse Transfer Capacitance		-	58	-	
t_{d(ON)}	Turn-on Delay Time	V _{GS} =10V, V _{DS} =25V, I _D =1A, R _{GEN} =1Ω	-	8.5	-	nS
t_r	Turn-on Rise Time		-	5.5	-	
t_{d(OFF)}	Turn-off Delay Time		-	26.9	-	
t_f	Turn-off Fall Time		-	40.5	-	
Q_g	Total Gate Charge	V _{GS} =4.5V, V _{DS} =20V I _D =20A	-	11.6	-	nC
Q_g	Total Gate Charge	V _{GS} =10V, V _{DS} =20V, I _D =20A	-	21.7	-	
Q_{gs}	Gate-Source Charge		-	3.2	-	
Q_{gd}	Gate-Drain Charge		-	6	-	
Source-Drain Characteristics						
V_{SD}^④	Diode Forward Voltage	I _{SD} =10A, V _{GS} =0V	-	0.75	1.1	V
t_{rr}	Reverse Recovery Time	I _F =10A, V _R =20V dI _F /dt=100A/μs	-	29.5	-	nS
Q_{rr}	Reverse Recovery Charge		-	14.1	-	nC

Note ④ : Pulse test (pulse width≤300us, duty cycle≤2%).

Note ⑤ : Guaranteed by design, not subject to production testing.

N-Channel Typical Characteristics

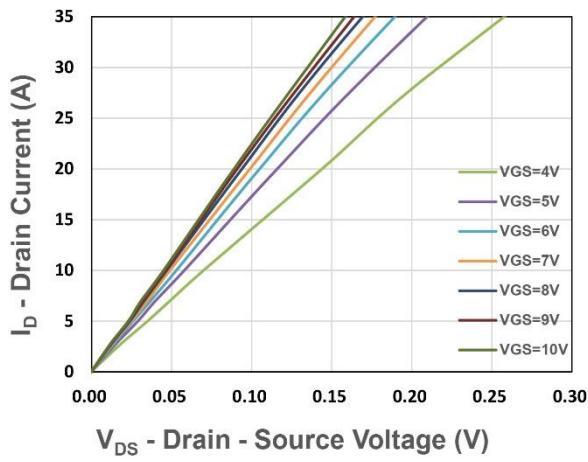


Figure 1. Output Characteristics

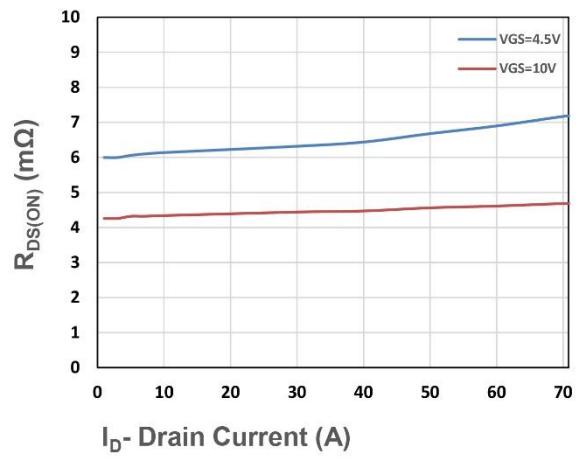


Figure 2. On-Resistance vs. ID

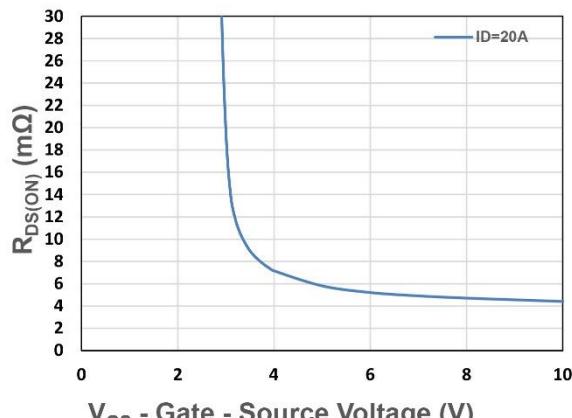


Figure 3. On-Resistance vs. VGS

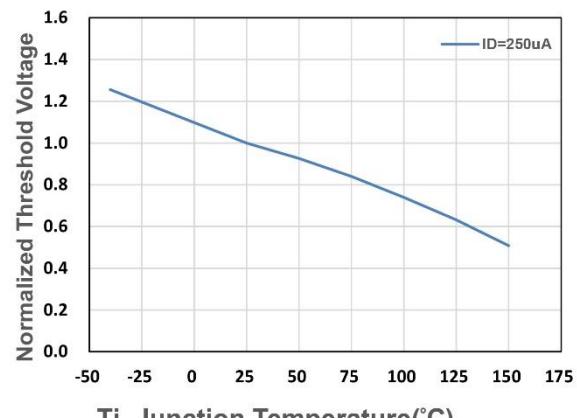


Figure 4. Gate Threshold Voltage

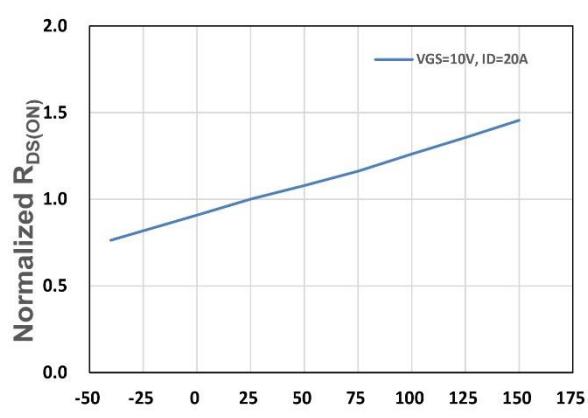


Figure 5. Drain-Source On Resistance

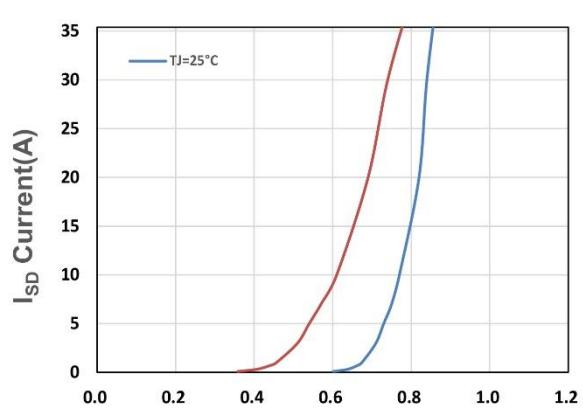
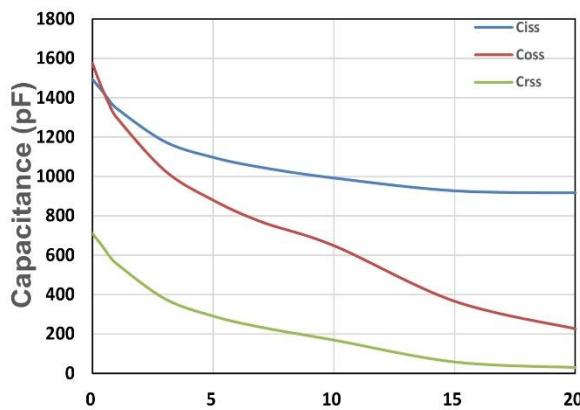
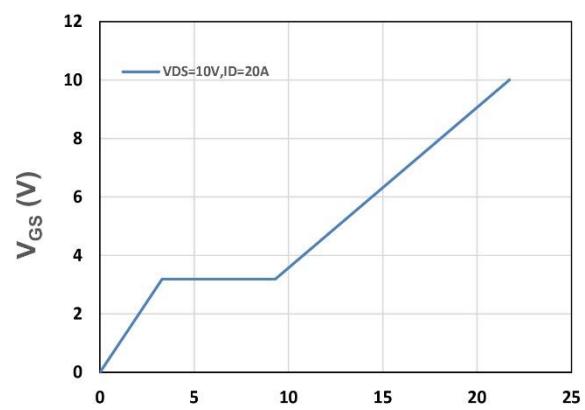


Figure 6. Source-Drain Diode Forward

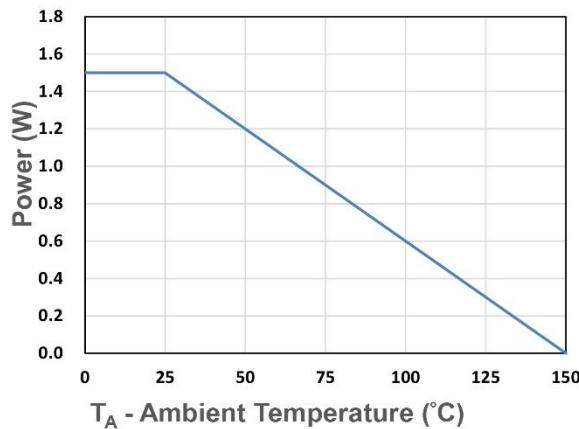
LM40060NAQ8A



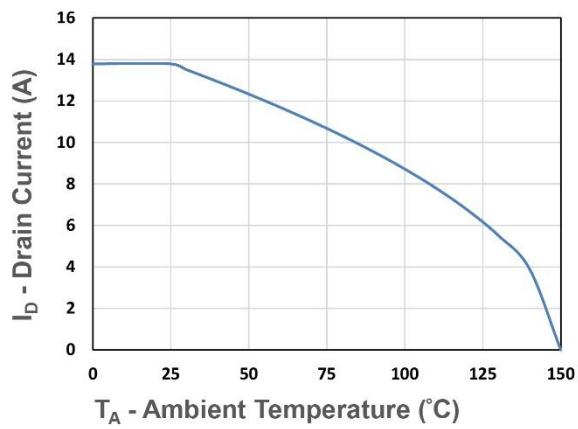
V_{DS} - Drain - Source Voltage (V)
Figure 7. Capacitance



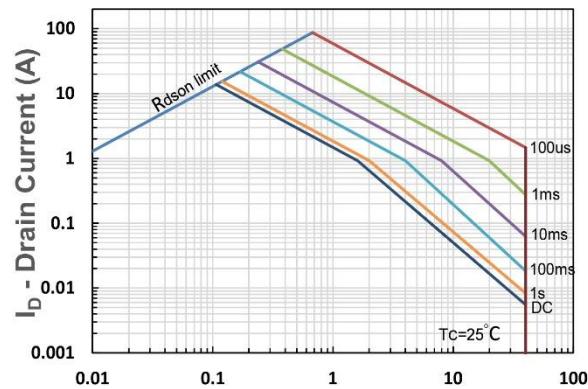
V_{GS} (V)
 Q_g , Total Gate Charge (nC)
Figure 8. Gate Charge Characteristics



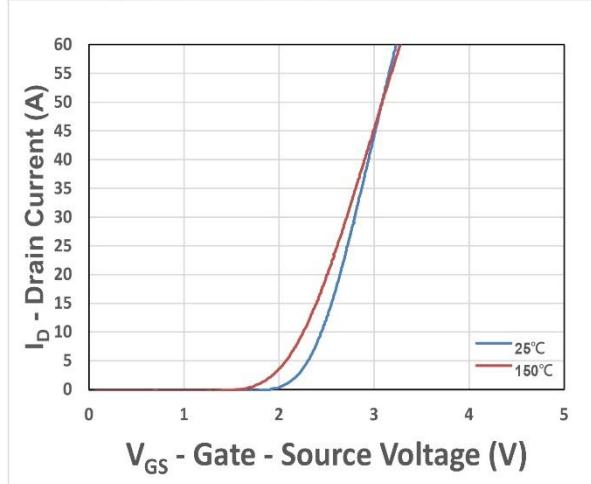
T_A - Ambient Temperature (°C)
Figure 9. Power Dissipation



I_D - Drain Current (A)
 T_A - Ambient Temperature (°C)
Figure 10. Drain Current



I_D - Drain Current (A)
 V_{DS} - Drain-Source Voltage (V)
Figure 11. Safe Operating Area



I_D - Drain Current (A)
 V_{GS} - Gate - Source Voltage (V)
Figure 12. Transfer Characteristics

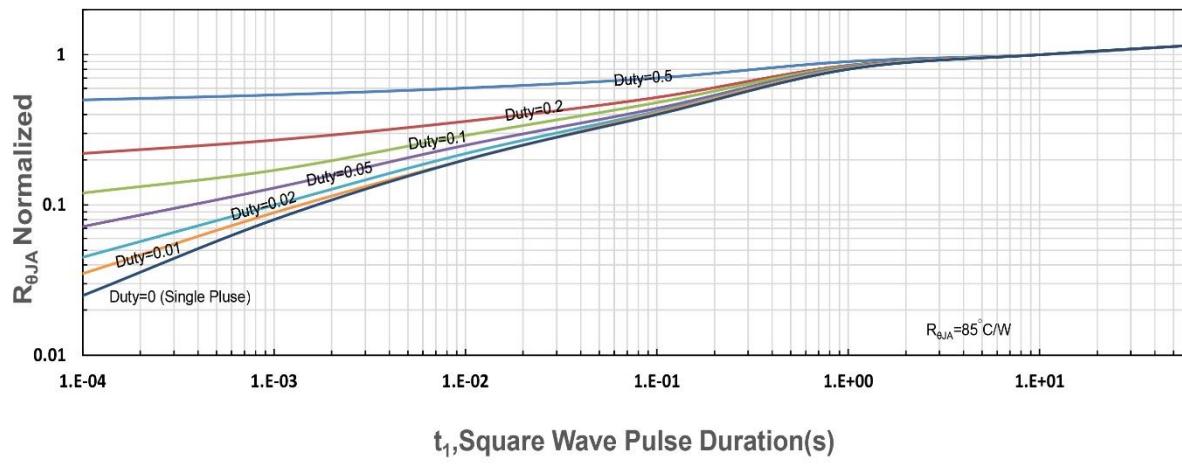


Figure 13. $R_{\theta JA}$ Transient Thermal Impedance